

**Application Data Sheet****Applicant Information**

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|-------------------------------|---------------|
| Applicant Authority type::    | Inventor      |
| Primary Citizenship Country:: | Japan         |
| Status::                      | Full Capacity |
| Given Name::                  | Shuichi       |
| Family Name::                 | OKAWA         |
| City of Residence::           | Tokyo         |
| Country of Residence::        | JAPAN         |

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| Applicant Authority Type::    | Inventor      |
| Primary Citizenship Country:: | Japan         |
| Status::                      | Full Capacity |
| Given Name::                  | Kazuhiro      |
| Family Name::                 | HATTORI       |
| City of Residence::           | Tokyo         |
| Country of Residence::        | JAPAN         |

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**Correspondence Information**

|                                  |       |
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| Correspondence Customer Number:: | 25944 |
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**Application Information**

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|--------------------------|--|
| Application Type::       | National Phase   |
| Subject Matter::         | Utility  |
| CD-ROM or CD-R::         | None   |
| Title::                  | MASK MATERIAL FOR REACTIVE ION<br>ETCHING, MASK, AND DRY ETCHING<br>METHOD |
| Attorney Docket Number:: | 125685   |
| Total Drawing Sheets::   | 7  |
| Small Entity::           | No   |

**Representative Information**

Attorneys associated with Customer No. 25944.

|   |                      |                             |                      |
|---|----------------------|-----------------------------|----------------------|
| <b>Domestic Priority Information</b>    |                      |                             |                      |
| Application::                           | Continuity Type::    | Parent Application::        | Parent Filing Date:: |
|   |                      |                             |                      |
| This Application is a                   | National Stage of    | PCT/JP04/008232             | 06/11/2004           |
|   |                      |                             |                      |
| <b>Foreign Priority Information</b>     |                      |                             |                      |
| Country::                               | Application Number:: | Filing Date::               | Priority Claimed::   |
|   |                      |                             |                      |
| JAPAN                                   | 2003-188468          | 06/30/2003                  | Yes                  |
|   |                      |                             |                      |
| <b>Assignee Information</b>             |                      |                             |                      |
| Assignee Name::                         |                      | TDK CORPORATION             |                      |
| Street of mailing address::             |                      | 1-13-1, Nihonbashi, Chuo-ku |                      |
| City of mailing address::               |                      | Tokyo                       |                      |
| Country of mailing address::            |                      | JAPAN                       |                      |
| Postal or Zip Code of mailing address:: |                      | 103-8272                    |                      |